www.DataSheer **TFA9800J** 2 × 7 W stereo power amplifier Rev. 01 — 17 March 2006

**Preliminary data sheet** 

#### **General description** 1.

The TFA9800 is an integrated class-AB dual output amplifier in a 9-pin DIL-bent-SIL (DBS9P) power package. The device is primarily developed for CRT and multi-media applications.

#### 2. **Features**

- Requires very few external components
- High output power
- Fixed gain
- Good ripple rejection
- Mute/standby switch
- AC and DC short-circuit safe to ground and V<sub>P</sub>
- Thermally protected
- Capability to handle high energy on outputs ( $V_P = 0 V$ )
- No switch-on/switch-off plop
- Electrostatic discharge protection

#### Quick reference data 3.

Table 1:	Quick reference data						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
VP	supply voltage	operating	[1]	6.0	15.0	18.0	V
		no output signal	[1]	-	-	20.0	V
I <sub>ORM</sub>	repetitive peak output current			-	-	2.5	А
I <sub>q(tot)</sub>	total quiescent current			-	40	80	mA
I <sub>stb</sub>	standby current			-	-	100	μΑ
Z <sub>i</sub>	input impedance			50	60	75	kΩ
Po	output power	${\sf R}_{\sf L}$ = 4 $\Omega;$ THD = 0.5 %	[2]	4.5	5.5	-	W
		$R_L = 4 \Omega$ ; THD = 10 %	[2]	6.0	7.0	-	W
SVRR	supply voltage rejection ratio	on; $f_i = 100 \text{ Hz}$ to 10 kHz		48	-	-	dB
$\alpha_{cs}$	channel separation	$R_{S} = 10 \text{ k}\Omega$		40	-	-	dB



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Table 1:	Quick	reference	data	continued
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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Gv	voltage gain	closed loop	19	20	21	dB
V <sub>n(o)(rms)</sub>	noise output voltage (RMS value)	on; $R_S = 0 \Omega$ ; f <sub>i</sub> = 20 Hz to 20 kHz	-	50	-	μV
Tj	junction temperature		-	-	150	°C

[1] The circuit is DC adjusted at V\_P = 6 V to 18 V and AC operating at V\_P = 8.5 V to 18 V.

[2] Output power is measured directly at the output pins of the TFA9800J.

## 4. Ordering information

Table 2: Ordering information
-------------------------------

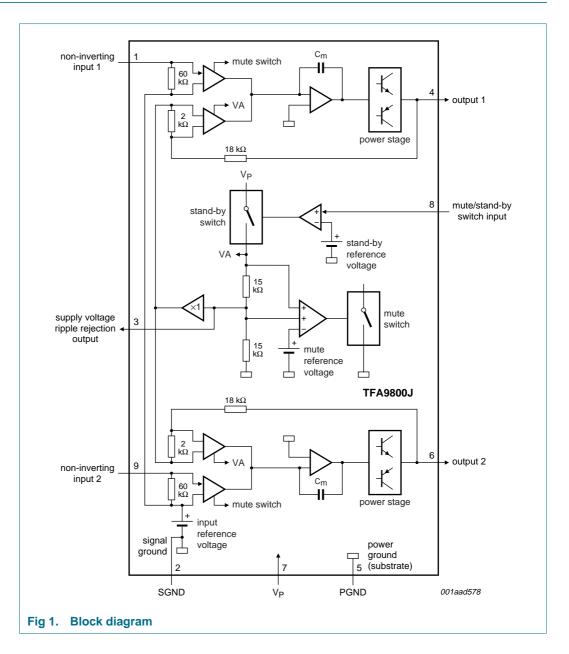
Type number	Package						
	Name	Description	Version				
TFA9800J	DBS9P	plastic DIL-bent-SIL power package; 9 leads (lead length 12/11 mm); exposed die pad	SOT523-1				

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## 5. Block diagram



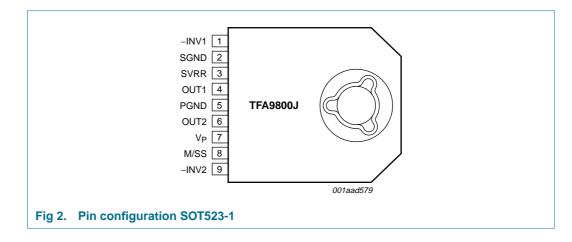
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## 6. Pinning information

#### 6.1 Pinning



### 6.2 Pin description

Table 3:	Pin description	
Symbol	Pin	Description
–INV1	1	non-inverting input 1
SGND	2	signal ground
SVRR	3	supply voltage ripple rejection output
OUT1	4	output 1
PGND	5	power ground
OUT2	6	output 2
V <sub>P</sub>	7	supply voltage
M/SS	8	mute/standby switch input
–INV2	9	non-inverting input 2

## 7. Functional description

The TFA9800J contains two identical amplifiers with differential input stages. The gain of each amplifier is fixed at 20 dB. A special feature of the device is the mute/standby switch which has the following features:

- Low standby current (< 100 μA)
- Low mute/standby switching current (low cost supply switch)
- Mute condition

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## 8. Limiting values

Symbol	Parameter	Conditions	Min	Max	Unit
VP	supply voltage	operating	<u>[1]</u> 6.0	15.0	18.0
		no output signal	<u>[1]</u> _	-	20.0
V <sub>P(sc)</sub>	short-circuit supply voltage		-	18	V
V <sub>P(r)</sub>	reverse supply voltage		-	6	V
E <sub>hand(O)</sub>	energy handling capacity at outputs	V <sub>P</sub> = 0 V	-	200	mJ
I <sub>OSM</sub>	non-repetitive peak output current		-	4	A
I <sub>ORM</sub>	repetitive peak output current		-	2.5	А
P <sub>tot</sub>	total power dissipation		-	25	W
T <sub>stg</sub>	storage temperature		-55	+150	°C
T <sub>amb</sub>	ambient temperature		-40	+85	°C
Tj	junction temperature		-	150	°C

[1] The circuit is DC adjusted at V<sub>P</sub> = 6 V to 18 V and AC operating at V<sub>P</sub> = 8.5 V to 18 V.

## 9. Thermal characteristics

Table 5:	Thermal characteristics			
Symbol	Parameter	Conditions	Тур	Unit
R <sub>th(j-c)</sub>	thermal resistance from junction to case		4	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	40	K/W

## **10. Static characteristics**

Table 6:	Static characteristic	S				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Supply						
VP	supply voltage		<u>[1]</u> 6.0	15	18.0	V
I <sub>q(tot)</sub>	total quiescent current		-	40	80	mA
I <sub>stb</sub>	standby current		-	-	100	μA
Vo	output voltage		-	7.2	-	V
Mute/star	ndby switch					
I <sub>I(sw)</sub>	switch input current		-	12	40	μA

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Table 6:	Static characteristics continued					
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
V <sub>th(on)</sub>	on threshold vol	age	8.5	-	-	V
V <sub>th(mute)</sub>	mute threshold voltage		3.3	-	6.4	V
V <sub>th(stb)</sub>	standby thresho voltage	d	0	-	2	V

[1] The circuit is DC adjusted at  $V_P = 6$  V to 18 V and AC operating at  $V_P = 8.5$  V to 18 V.

## 11. Dynamic characteristics

#### Table 7: Dynamic characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Po	output power	$R_{L}$ = 4 $\Omega$ ; THD = 0.5 %	<u>[1]</u>	4.5	5.5	-	W
		$R_L = 4 \Omega$ ; THD = 10 %	<u>[1]</u>	6.0	7.0	-	W
THD	total harmonic distortion	P <sub>o</sub> = 1 W		-	0.1	-	%
f <sub>-3db(l)</sub>	low frequency –3 dB point		[2]	-	45	-	Hz
f <sub>-1db(h)</sub>	high frequency –1 dB point			20	-	-	kHz
G <sub>v</sub>	voltage gain	closed loop		19	20	21	dB
∆G <sub>v</sub>	voltage gain difference			-	0.1	1	dB
SVRR	supply voltage	$f_i = 100 \text{ Hz}$ to 10 kHz					
	rejection ratio	on	[3]	48	-	-	dB
		mute	[3]	48	-	-	dB
		standby	[3]	80	-	-	dB
Z <sub>i</sub>	input impedance			50	60	75	kΩ
V <sub>n(o)(rms)</sub>	noise output voltage	$f_i = 20 \text{ Hz to } 20 \text{ kHz}$					
	(RMS value)	on; $R_S = 0 \Omega$	[4]	-	50	-	μV
		on; $R_S = 10 \text{ k}\Omega$	[4]	-	70	100	μV
		mute	[5]	-	50	-	μV
V <sub>O(mute)</sub>	mute output voltage	$V_{I(max)} = 1 V;$ $f_i = 20 Hz$ to 15 kHz		-	-	2	mV
$\alpha_{cs}$	channel separation	R <sub>S</sub> = 10 kΩ		40	-	-	dB

[1] Output power is measured directly at the output pins of the IC.

[2] Frequency response externally fixed.

- [3] Ripple rejection measured at the output with a source impedance of 0  $\Omega$ , maximum ripple amplitude of 2 V (p-p) and a frequency between 100 Hz and 10 kHz.
- [4] Noise voltage measured in a bandwidth of 20 Hz to 20 kHz.
- [5] Noise output voltage independent of  $R_S$  (V<sub>I</sub> = 0 V).

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## **12. Application information**

#### 12.1 Printed-Circuit Board (PCB) layout and grounding

For high system performance level, certain grounding techniques are imperative. The input reference grounds have to be tied with their respective source grounds and must have separate traces from the power ground traces; this will prevent the large (output) signal currents from interfering with the small AC input signals. The small-signal ground traces should be physically located as far as possible from the power ground traces. The width of supply and output traces should be as large as practical for delivering maximum output power.

Proper supply bypassing is critical for low noise performance and high power supply rejection. The respective capacitor locations should be as close as possible to the device and grounded to the power ground. Proper power supply decoupling also prevents oscillations. For suppressing higher frequency transients (spikes) on the supply line a capacitor with low Equivalent Series Resistance (ESR), typical 0.1  $\mu$ F, has to be placed as close as possible to the device. For suppressing lower frequency noise and ripple signals, a large electrolytic capacitor, e.g. 1000  $\mu$ F or greater, must be placed close to the TFA9800J.

In a single-ended (stereo) application a bypass capacitor on the SVRR pin reduces the noise and ripple on the mid-rail voltage. For good THD and noise performance a low ESR capacitor is recommended.

#### **12.2 Input configuration**

It should be noted that the DC level of the input pins is about 2.1 V, therefore a coupling capacitor is necessary.

The input cut-off frequency is: 
$$f_i = \frac{1}{2\pi R_i C_i} \Rightarrow f_i = \frac{1}{2\pi \times 30 \times 10^3 \times 220 \times 10^{-9}} = 24 \text{ Hz}$$

This calculation shows that it is not necessary to use high capacitor values for the input; so the delay during switch-on, which is necessary for charging the input capacitors, can be minimized. This results in a good low frequency response and good switch-on behavior.

For stereo application (single-ended) coupling capacitors on both input and output are necessary.

#### 12.3 Built-in protection circuits

The TFA9800J contains two kinds of protection circuits:

- Short-circuit of outputs to ground, supply and across the load: short-circuit is detected and controlled by a Safe Operating ARea (SOAR) protection circuit.
- Thermal shutdown protection: the junction temperature is measured by a temperature sensor; at a junction temperature of > 150 °C, thermal fold back is activated.

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#### 12.4 Output power

The output power versus supply voltage has been measured on the output pins and at THD = 10 %. The maximum output power is limited by the maximum allowable power dissipation and the maximum available output current: 2.5 A repetitive peak current; see Figure 13.

#### 12.5 Supply voltage ripple rejection

The SVRR has been measured with an electrolytic capacitor of 100  $\mu$ F on pin 3 and at a bandwidth of 10 Hz to 80 kHz. Both curves for operating and mute condition were measured with R<sub>S</sub> = 25  $\Omega$ ; see Figure 9.

#### 12.6 Headroom

A typical music CD requires at least 12 dB (= factor 15.85) dynamic headroom compared with the average power output for passing the loudest portions without distortion. The following calculation can be made for this application at  $V_P = 15$  V and  $R_L = 4 \Omega$ :

 $P_o$  at THD = 0.2 % is about 4.5 W; see <u>Figure 7</u>. Average Listening Level (ALL) without any distortion yields:  $P_o = 4.5$  W / 15.85 = 284 mW. From <u>Figure 11</u>, the power dissipation can be derived for a headroom of 0 dB and 12 dB respectively:

#### Table 8:Power rating

Condition	Headroom	Power dissipation
$P_o = 4.5 \text{ W} \text{ at THD} = 0.2 \%$	0 dB	6 W
	12 dB	4 W

So for average listening level music power, a power dissipation of 4 W can be used for the thermal behavior calculation as described in <u>Section 12.9</u> "Thermal behavior".

#### 12.7 Pin M/SS

For the three functional modes: Standby mode, Mute mode, and Operating mode, pin M/SS can be driven by a 3-state logic output stage, e.g. microcontroller with some extra components for DC-level shifting; see Figure 10 for the respective DC levels.

- Standby mode is activated by a low DC level, between 0 V and 2 V on pin M/SS. The power consumption of the TFA9800J will be reduced to < 0.1 mW</li>
- Mute mode will be activated by a DC level between 3.3 V and 6.4 V. The outputs of the amplifier will be muted (no audio output), however the amplifier is DC biased and the DC level of the output pins remains on half the supply voltage. The input coupling capacitors are charged when in Mute mode to avoid plop noise.
- The TFA9800J will be in Operating mode at pin M/SS voltages between 8.5 V and  $V_{\text{P}}$

#### 12.8 Switch on and switch off

To avoid audible plops during switch on or switch off of the supply voltage, pin M/SS has to be set in Standby condition (GND level) before the voltage is applied (switch-on) or removed (switch-off). Via the Mute mode the input- and SVRR-capacitors are smoothly charged (or discharged). The slope of the SVRR-voltage should be well controlled and

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slow. Unfortunately, the slope of the SVRR voltage is not well controlled in the phase where the SVRR voltage is between ground and ground + 0.7 V. In other words SVRR makes a step and so does the output. Consequently a plop sound can occur.

Solution is to give the SVRR pin a bias, see anti plop 1 in Figure 4. A second improvement is to give the DC-outputs of the load a bias, see anti plop 2 Figure 4.

The turn-on and turn-off time can be influenced by an RC-circuit on the pin M/SS; see anti plop 3 in <u>Figure 4</u>. Rapid on/off switching of the device or pin M/SS may cause click and plop noise. A proper timing on pin M/SS can prevent this; see <u>Figure 4</u>.

#### 12.9 Thermal behavior

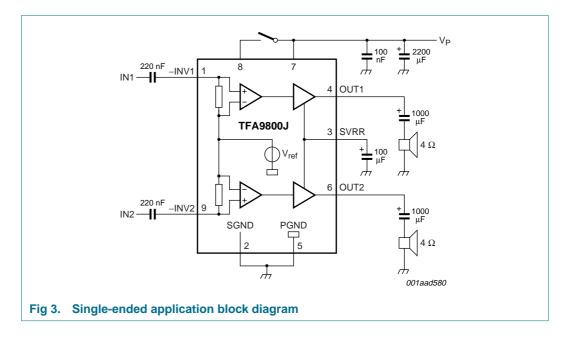
The typical thermal resistance of the TFA9800J in the DBS9P package ( $R_{th(j-c)}$ ) is 4 K/W. The thermal resistance ( $R_{th(h-a)}$ ) of an aluminium heat-sink with a (one-side) area of about 22 cm<sup>2</sup> is about 16 K/W. For a maximum ambient temperature of 60 °C the following calculation can be made for the application at  $V_P = 15$  V,  $R_L = 4 \Omega$  and the ALL music power dissipation is about 4 W:

 $T_{j(max)} = T_{amb} + P_{tot} \times (R_{th(j-c)} + R_{th(h-a)}) \Rightarrow T_{j(max)} = 60 + 4.0 \times (4 + 16) = 140 \ ^{\circ}C$ 

**Remark:** The calculation holds for applications at average listening level music output signals. Applying or testing with sine wave signals will produce about  $1.5 \times$  the music power dissipation. At worst-case condition this can activate the maximum temperature protection.

#### 12.10 Application diagram and board layout

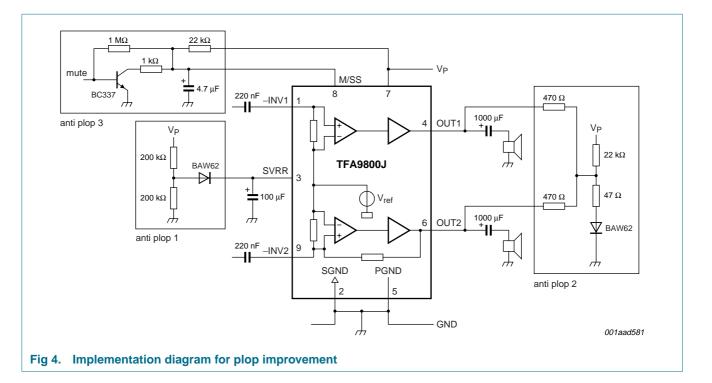
The single-ended application circuit diagram is shown in <u>Figure 3</u>. The PCB layout for this application is shown in Figure 5 and Figure 6.

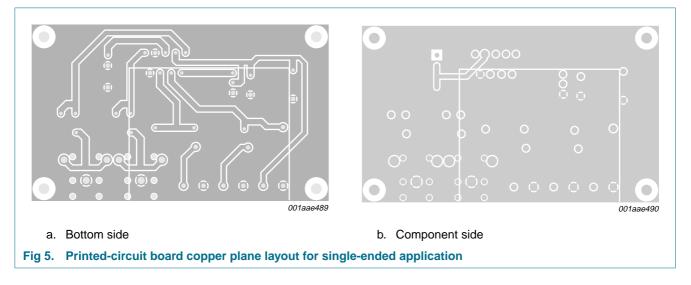


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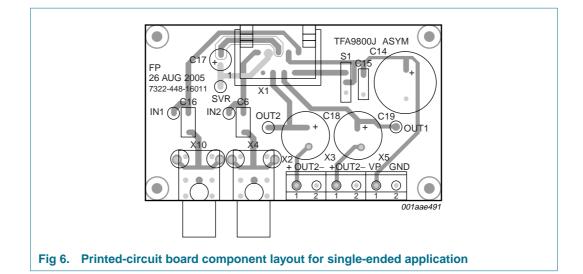




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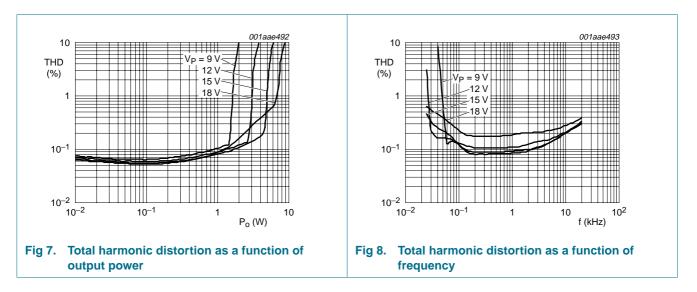
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#### 12.11 Typical performance characteristics for single-ended application

The test conditions, unless otherwise specified, are:  $T_{amb} = 25 \text{ °C}$ ;  $V_P = 15 \text{ V}$ ;  $f_i = 1 \text{ kHz}$ ;  $R_L = 4 \Omega$ ; single-ended stereo application; fixed gain equals 20 dB; audio band pass from 22 Hz to 22 kHz. All graphs show typical curves.

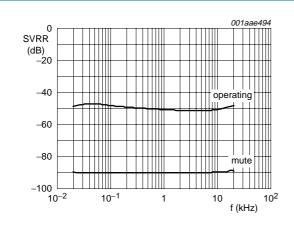
The graphs as a function of frequency use a band pass of 20 Hz to 80 kHz.



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 $\mathsf{R}_\mathsf{S}$  = 25  $\Omega$ 

Fig 9. Supply voltage ripple rejection as a function of frequency

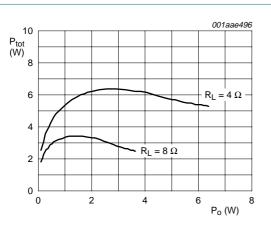
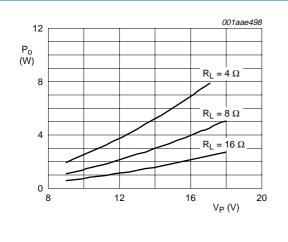
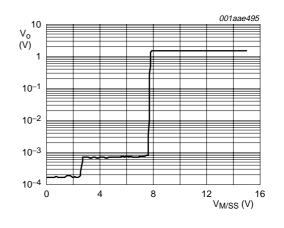


Fig 11. Total power dissipation (worst case, both channels driven) as a function of output power per channel









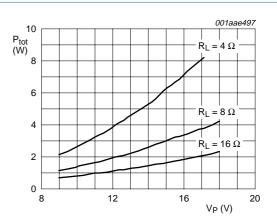
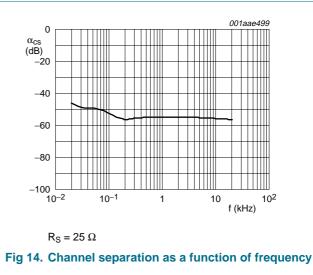


Fig 12. Total power dissipation (worst case, both channels driven) as a function of supply voltage



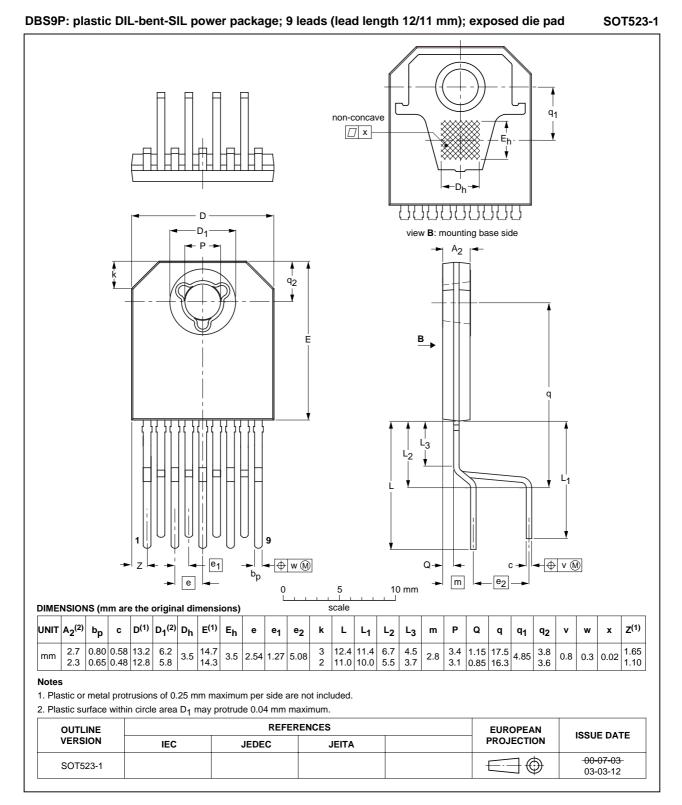
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## 13. Package outline



## Fig 15. Package outline SOT523-1 (DBS9P)

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## 14. Soldering

#### 14.1 Introduction to soldering through-hole mount packages

This text gives a brief insight to wave, dip and manual soldering. A more in-depth account of soldering ICs can be found in our *Data Handbook IC26; Integrated Circuit Packages* (document order number 9398 652 90011).

Wave soldering is the preferred method for mounting of through-hole mount IC packages on a printed-circuit board.

#### 14.2 Soldering by dipping or by solder wave

Driven by legislation and environmental forces the worldwide use of lead-free solder pastes is increasing. Typical dwell time of the leads in the wave ranges from 3 seconds to 4 seconds at 250 °C or 265 °C, depending on solder material applied, SnPb or Pb-free respectively.

The total contact time of successive solder waves must not exceed 5 seconds.

The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified maximum storage temperature  $(T_{stg(max)})$ . If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature within the permissible limit.

#### 14.3 Manual soldering

Apply the soldering iron (24 V or less) to the lead(s) of the package, either below the seating plane or not more than 2 mm above it. If the temperature of the soldering iron bit is less than 300 °C it may remain in contact for up to 10 seconds. If the bit temperature is between 300 °C and 400 °C, contact may be up to 5 seconds.

#### 14.4 Package related soldering information

Table 9:	Suitability of through-hole mount IC packages for dipping and wave soldering
	methods

Package	Soldering method		
	Dipping	Wave	
CPGA, HCPGA	-	suitable	
DBS, DIP, HDIP, RDBS, SDIP, SIL	suitable	suitable [1]	
PMFP <sup>[2]</sup>	-	not suitable	

[1] For SDIP packages, the longitudinal axis must be parallel to the transport direction of the printed-circuit board.

[2] For PMFP packages hot bar soldering or manual soldering is suitable.

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## 15. Revision history

Table 10: Revision history					
Document ID	Release date	Data sheet status	Change notice	Doc. number	Supersedes
TFA9800J_1	20060317	Preliminary data sheet	-	-	-

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# **TFA9800J**

## 16. Data sheet status

Level	Data sheet status [1]	Product status [2] [3]	Definition
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
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[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

## **17. Definitions**

**Short-form specification** — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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